

7MHz, Precision, Rail-to-Rail I/O CMOS Operational Amplifier

1 FEATURES

- **Gain Bandwidth: 7MHz**
- **Rail-to-Rail Input and Output**
3mV Max Vos
- **Input Voltage Range: -0.1V to +5.6V**
with Vs = 5.5V
- **Supply Range: +2.4V to +5.5V**
- **Specified Up to +125°C**
- **Micro Size Packages: SOT23-5**

2 APPLICATIONS

- **Sensors**
- **Photodiode Amplification**
- **Active Filters**
- **Test Equipment**
- **Driving A/D Converters**

3 DESCRIPTIONS

The RS621K offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (7MHz) and slew rate of 3.7V/ μ s. The op-amps are unity gain stable and feature an ultra-low input bias current.

The RS621K has lower offset, which is guaranteed not upper than 3mV at 25°C with Vs = 5V, V_{CM} = Vs/2.

The devices are ideal for sensor interfaces, active filters and portable applications. The RS621K is specified at the full temperature range of -40°C to +125°C under single or dual power supplies of 2.4V to 5.5V.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE(NOM)
RS621K	SOT23-5	2.90mm×1.60mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Table of Contents

1 FEATURES	1
2 APPLICATIONS	1
3 DESCRIPTIONS	1
4 REVISION HISTORY	3
5 PACKAGE/ORDERING INFORMATION ⁽¹⁾	4
6 PIN CONFIGURATION AND FUNCTIONS	5
7 SPECIFICATIONS.....	6
7.1 Absolute Maximum Ratings	6
7.2 ESD Ratings	6
7.3 Recommended Operating Conditions.....	6
7.4 Electrical Characteristics.....	7
7.5 Typical Characteristics	9
8 DETAILED DESCRIPTION	13
8.1 Overview.....	13
8.2 Phase Reversal Protection.....	13
8.3 EMI Rejection Ratio (EMIRR)	13
8.4 EMIRR IN+ Test Configuration.....	14
9 APPLICATION AND IMPLEMENTATION	15
9.1 Application Note	15
9.2 25-kHz Low-pass Filter	15
9.3 Design Requirements	15
9.4 Detailed Design Procedure	15
9.5 Application Curve.....	16
10 LAYOUT	17
10.1 Layout Guideline	17
10.2 Layout Example	17
11 PACKAGE OUTLINE DIMENSIONS	18
12 TAPE AND REEL INFORMATION.....	19

4 REVISION HISTORY

Note: Page numbers for previous revisions may differ from page numbers in the current version.

VERSION	Change Date	Change Item
C.1	2022/05/19	1. Increase the minimum junction temperature 2. Add TAPE AND REEL INFORMATION
C.1.1	2024/03/01	Modify packaging naming
C.2	2025/01/08	1. Delete RS621KXC5/RS621BKXC5/RS621KXK/RS621KXM Orderable Device 2. Add MSL on Page 5 in RevC.1.1 3. Add Package thermal impedance on Page 4 in RevC.1.1 4. Update PACKAGE note

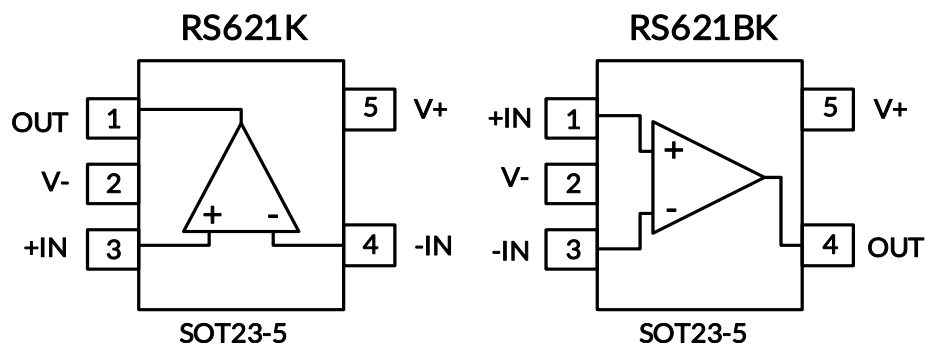
5 PACKAGE/ORDERING INFORMATION ⁽¹⁾

Orderable Device	Package Type	Pin	Channel	Op Temp(°C)	Device Marking ⁽²⁾	MSL ⁽³⁾	Package Qty
RS621KXF	SOT23-5	5	1	-40°C ~125°C	621K	MSL3	Tape and Reel,3000
RS621BKXF	SOT23-5	5	1	-40°C ~125°C	621BK	MSL3	Tape and Reel,3000

NOTE:

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) Runic classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F. Please align with Runic if your end application is quite critical to the preconditioning setting or if you have special requirement.

6 PIN CONFIGURATION AND FUNCTIONS



PIN DESCRIPTION

NAME	PIN		I/O ⁽¹⁾	DESCRIPTION
	RS621K	RS621BK		
	SOT23-5	SOT23-5		
-IN	4	3	I	Negative (inverting) input
+IN	3	1	I	Positive (noninverting) input
OUT	1	4	O	Output
V-	2	2	-	Negative (lowest) power supply
V+	5	5	-	Positive (highest) power supply

(1) I = Input, O = Output.

7 SPECIFICATIONS

7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

		MIN	MAX	UNIT
Voltage	Supply, $V_S = (V+) - (V-)$		7	V
	Signal input pin ⁽²⁾	(V-)-0.5	(V+) +0.5	
	Signal output pin ⁽³⁾	(V-)-0.5	(V+) +0.5	
Current	Signal input pin ⁽²⁾	-10	10	mA
	Signal output pin ⁽³⁾	-140	140	mA
	Output short-circuit ⁽⁴⁾	Continuous		
θ_{JA}	Package thermal impedance ⁽⁵⁾	SOT23-5	230	°C/W
Temperature	Operating range, T_A	-40	125	°C
	Junction, T_J ⁽⁶⁾	-40	150	
	Storage, T_{stg}	-65	150	

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

(3) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to ± 140 mA or less.

(4) Short-circuit to ground, one amplifier per package.

(5) The package thermal impedance is calculated in accordance with JEDEC-51.

(6) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

7.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-Body Model (HBM)	± 3000	V
		Machine Model (MM)	± 200	



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

7.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage, $V_S = (V+) - (V-)$	Single-supply	2.4		5.5	V
	Dual-supply	± 1.2		± 2.75	

7.4 Electrical Characteristics

(At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, and $V_{OUT} = V_S/2$, Full ⁽⁹⁾ = -40°C to 125°C , unless otherwise noted.) ⁽¹⁾

PARAMETER		CONDITIONS	T _J	RS621K			
				MIN ⁽²⁾	TYP ⁽³⁾	MAX ⁽²⁾	UNITS
POWER SUPPLY							
V _S	Operating Voltage Range		25°C	2.4		5.5	V
I _Q	Quiescent Current Per Amplifier		25°C		700	900	μA
PSRR	Power-Supply Rejection Ratio	V _S =2.4V to 5.5V, V _{CM} =(V-)+0.5V	25°C	75	92		dB
			Full	65			
INPUT							
V _{OS}	Input Offset Voltage	V _{CM} =0V to 3.5V	25°C	-3	0.8	3	mV
V _{OS} T _C	Input offset voltage drift		Full		2		μV/°C
I _B	Input Bias Current ^{(4) (5)}		25°C		1	10	pA
I _{OS}	Input Offset Current ⁽⁴⁾		25°C		1	10	pA
V _{CM}	Common-Mode Voltage Range	V _S = 5.5V	25°C	-0.1		5.6	V
CMRR	Common-Mode Rejection Ratio	V _S = 5.5V, V _{CM} =-0.1V to 4V	25°C	75	95		dB
			Full	68			
		V _S = 5.5V, V _{CM} =-0.1V to 5.6V	25°C	63	80		
			Full	57			
OUTPUT							
A _{OL}	Open-Loop Voltage Gain	R _L =10KΩ, V _O =0.15V to 4.85V	25°C	95	110		dB
			Full	85			
		R _L =2KΩ, V _O = 0.05V to 4.95V	25°C	100	120		
			Full	92			
	Output Swing From Rail	R _L =2KΩ	25°C		40		mV
		R _L =10KΩ			7		
I _{OUT}	Output Current Source ^{(6) (7)}		25°C		120		mA
FREQUENCY RESPONSE							
SR	Slew Rate ⁽⁸⁾		25°C		3.7		V/μs
GBP	Gain-Bandwidth Product		25°C		7		MHz
PM	Phase Margin		25°C		64		°
t _S	Settling Time, 0.1%		25°C		0.5		μs
t _{OR}	Overload recovery time	V _{IN} ×Gain≥V _S	25°C		0.5		μs
NOISE							
e _n	Input Voltage Noise Density	f = 1KHz	25°C		11		nV/√Hz
		f = 10KHz	25°C		7.5		nV/√Hz

NOTE:

- (1) Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.
- (4) This parameter is ensured by design and/or characterization and is not tested in production.
- (5) Positive current corresponds to current flowing into the device.
- (6) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.
- (7) Short circuit test is a momentary test.
- (8) Number specified is the slower of positive and negative slew rates.
- (9) Specified by characterization only.

7.5 Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

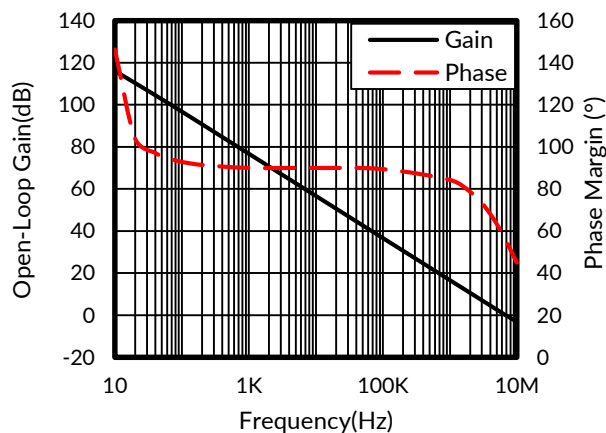


Figure 1. Open-Loop Gain And Phase vs Frequency

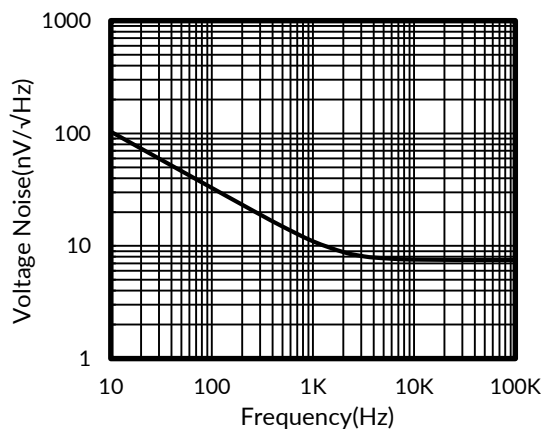


Figure 2. Input Voltage Noise Spectral Density vs Frequency

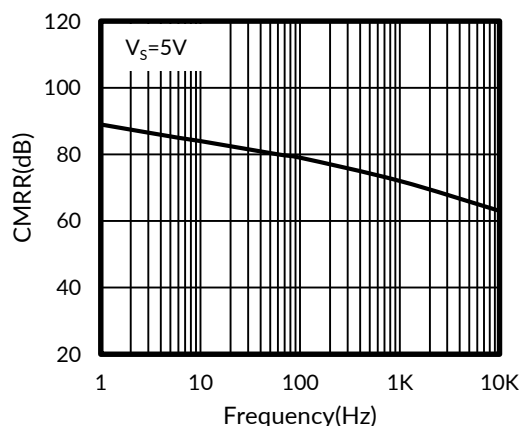


Figure 3. Common-Mode Rejection Ratio vs Frequency

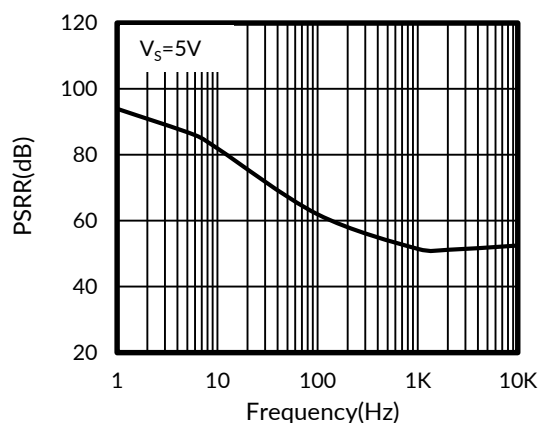


Figure 4. Power-Supply Rejection Ratio vs Frequency

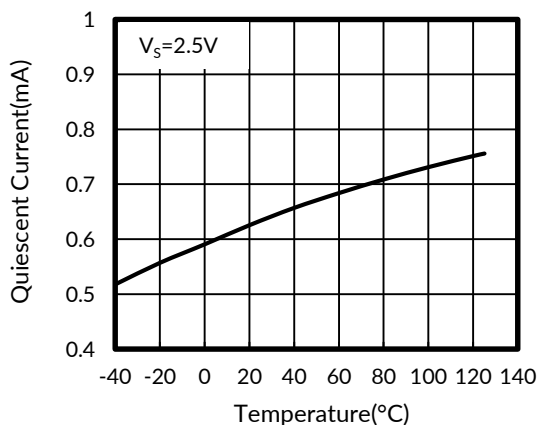


Figure 5. Quiescent Current vs Temperature

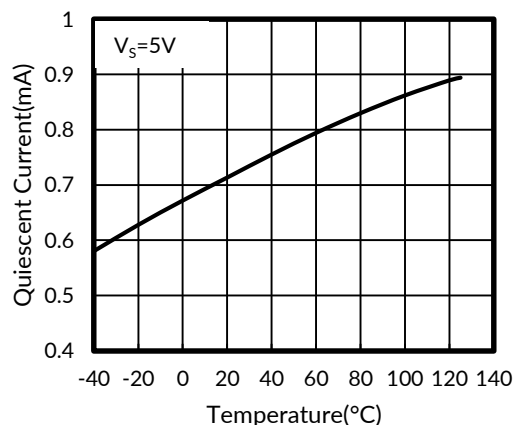


Figure 6. Quiescent Current vs Temperature

Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

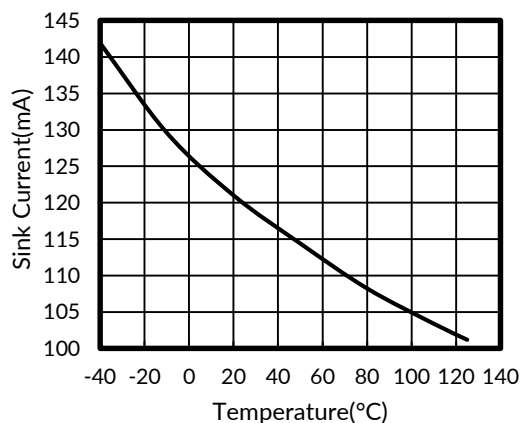


Figure 7. Sink Current vs Temperature

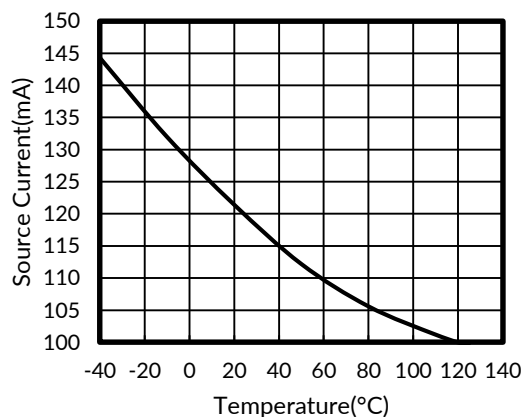


Figure 8. Source Current vs Temperature

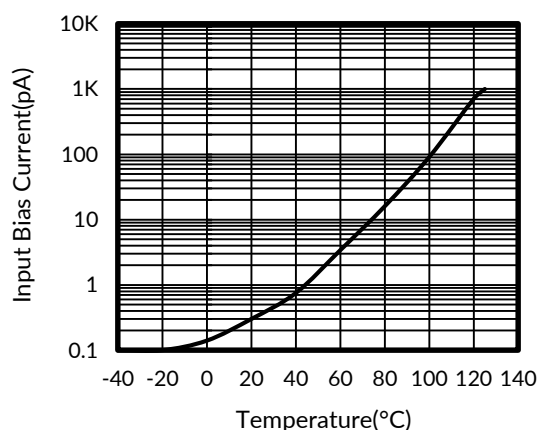


Figure 9. Input Bias Current vs Temperature

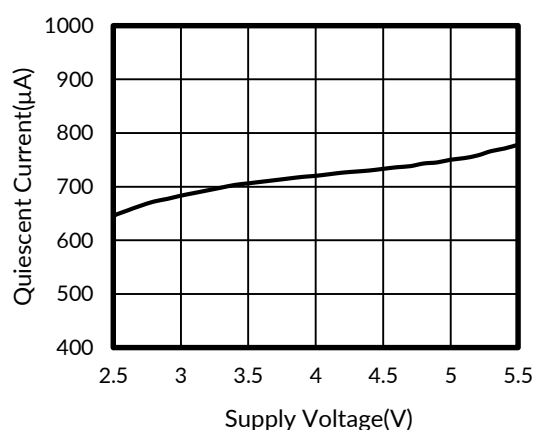


Figure 10. Quiescent Current vs Supply Voltage

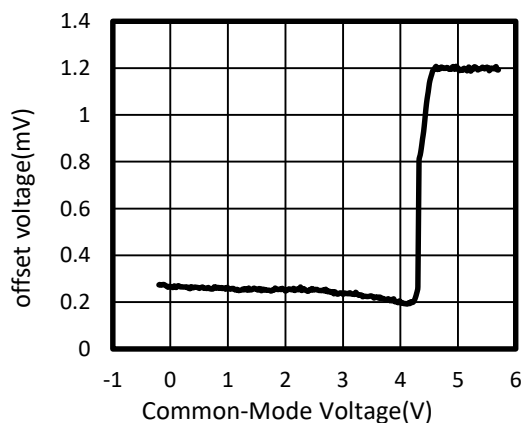


Figure 11. Offset Voltage vs Common-Mode Voltage

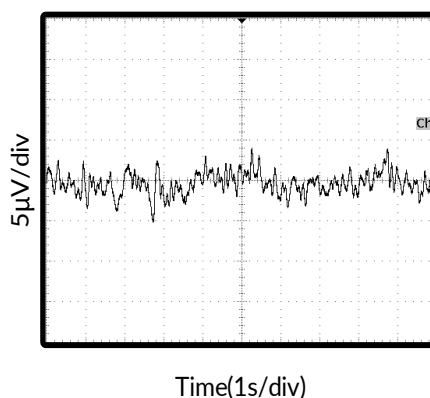


Figure 12. 0.1Hz To 10Hz Input Voltage Noise

Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

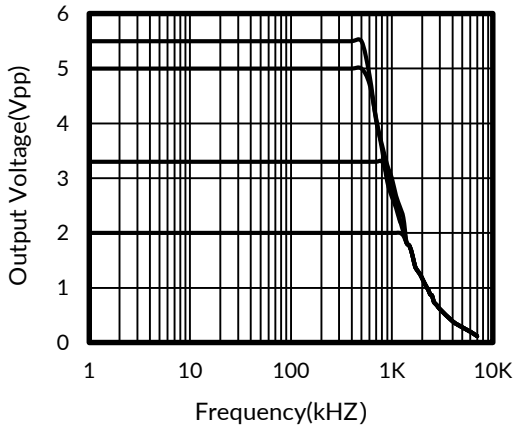


Figure 13. Maximum Output Voltage vs Frequency

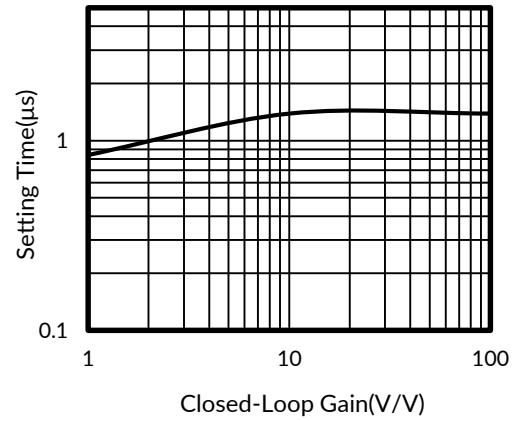


Figure 14. Setting Time vs Closed-Loop Gain

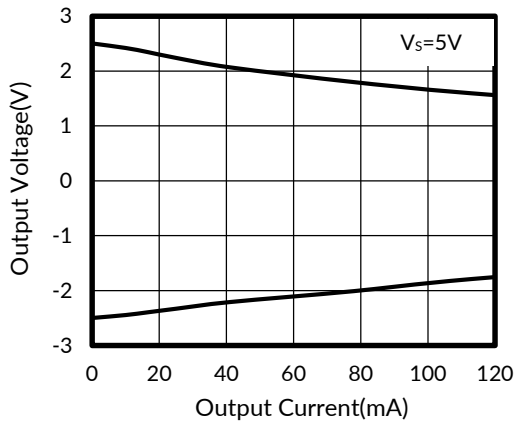


Figure 15. Output Voltage vs Output Current

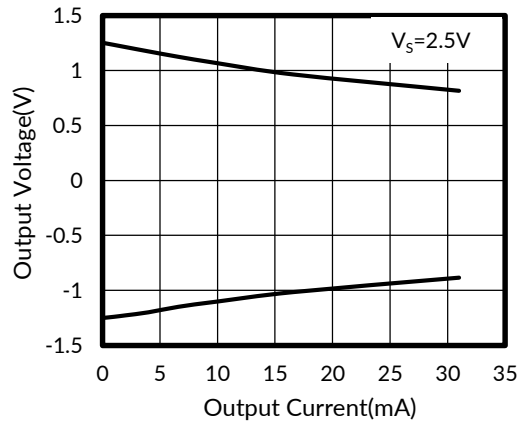


Figure 16. Output Voltage vs Output Current

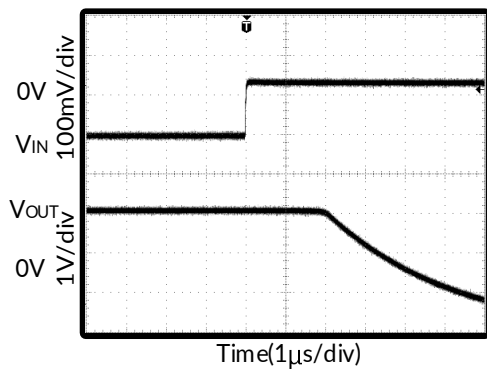


Figure 17. Positive Overload Recovery

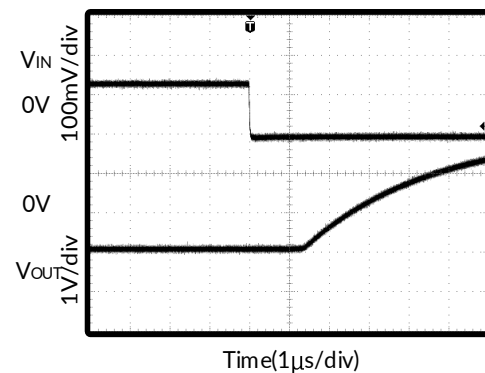


Figure 18. Negative Overload Recovery

Typical Characteristics

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 10\text{k}\Omega$ connected to $V_S/2$, $V_{OUT} = V_S/2$, unless otherwise noted.

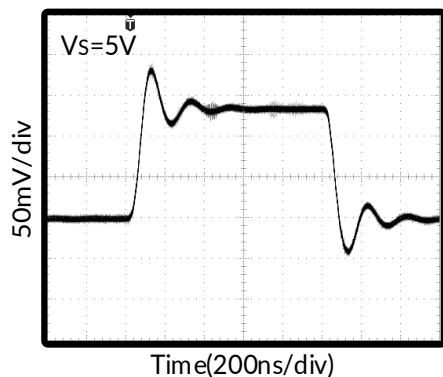


Figure 19. Small-Signal Step Response

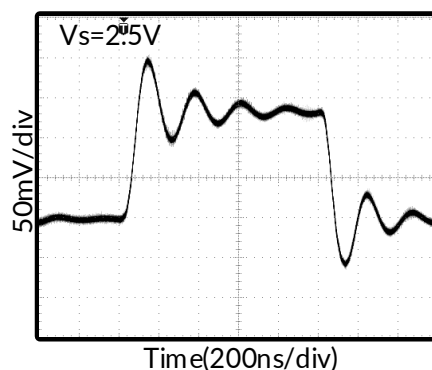


Figure 20. Small-Signal Step Response

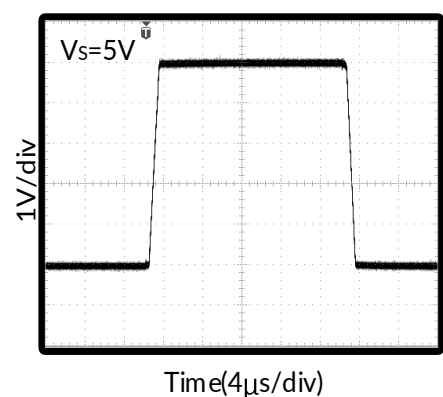


Figure 21. Large-Signal Step Response

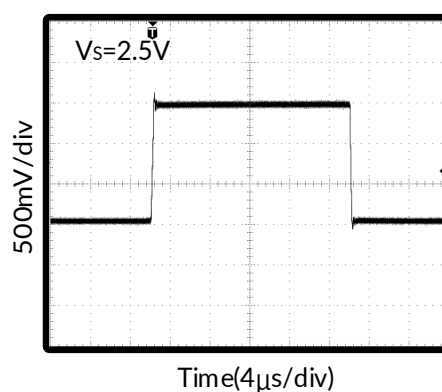


Figure 22. Large-Signal Step Response

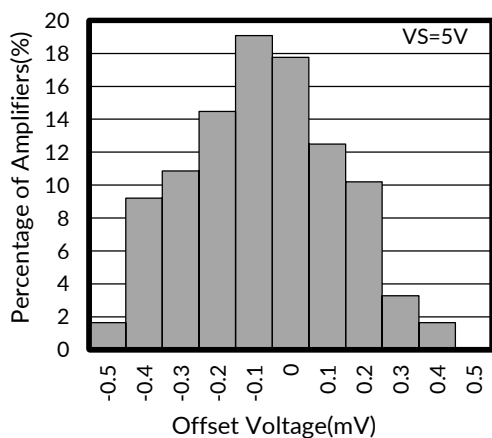


Figure 23. Offset Voltage Production Distribution

8 DETAILED DESCRIPTION

8.1 Overview

The RS621K devices are unity-gain stable, dual and quad-channel op amps with low noise and distortion. The device consists of a low noise input stage with a folded cascade and a rail-to-rail output stage. This topology exhibits superior noise and distortion performance across a wide range of supply voltages that are not delivered by legacy commodity audio operational amplifiers.

8.2 Phase Reversal Protection

The RS621K family has internal phase-reversal protection. Many op amps exhibit phase reversal when the input is driven beyond the linear common-mode range. This condition is most often encountered in noninverting circuits when the input is driven beyond the specified common-mode voltage range, causing the output to reverse into the opposite rail. The input of the RS621K prevents phase reversal with excessive common-mode voltage. Instead, the appropriate rail limits the output voltage. This performance is shown in figure 24.

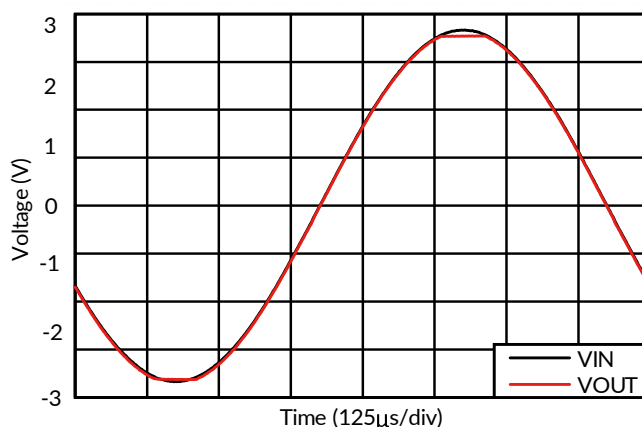


Figure 24. Output Waveform Devoid of Phase Reversal During an Input Overdrive Condition

8.3 EMI Rejection Ratio (EMIRR)

The electromagnetic interference (EMI) rejection ratio, or EMIRR, describes the EMI immunity of operational amplifiers. An adverse effect that is common to many operational amplifiers is a change in the offset voltage as a result of RF signal rectification. An operational amplifier that is more efficient at rejecting this change in offset as a result of EMI has a higher EMIRR and is quantified by a decibel value. Measuring EMIRR can be performed in many ways, but this document provides the EMIRR IN+, which specifically describes the EMIRR performance when the RF signal is applied to the noninverting input pin of the operational amplifier. In general, only the noninverting input is tested for EMIRR for the following three reasons:

- Operational amplifier input pins are known to be the most sensitive to EMI, and typically rectify RF signals better than the supply or output pins.
- The noninverting and inverting operational amplifier inputs have symmetrical physical layouts and exhibit nearly matching EMIRR performance.
- EMIRR is easier to measure on noninverting pins than on other pins because the noninverting input pin can be isolated on a printed-circuit-board (PCB). This isolation allows the RF signal to be applied directly to the noninverting input pin with no complex interactions from other components or connecting PCB traces.

DETAILED DESCRIPTION(continued)

The EMIRR IN+ of the RS621K is plotted versus frequency in Figure 25. If available, any dual and quad operational amplifier device versions have approximately identical EMIRR IN+ performance. The RS621K unity-gain bandwidth is 7MHz. EMIRR performance below this frequency denotes interfering signals that fall within the operational amplifier bandwidth.

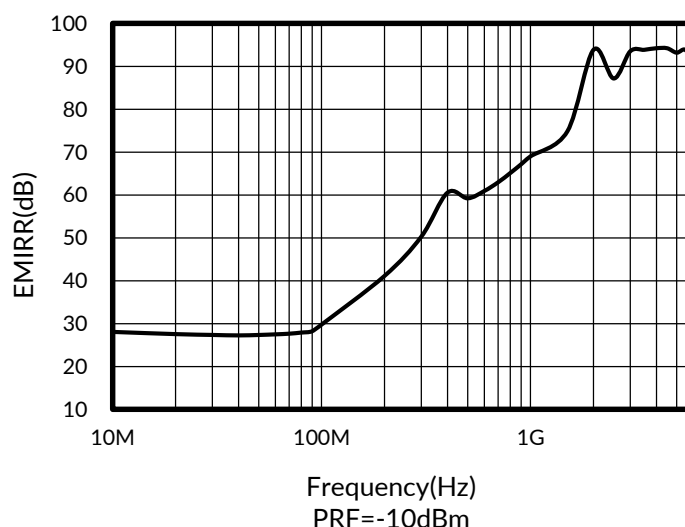


Figure 25. RS621K EMIRR vs Frequency

8.4 EMIRR IN+ Test Configuration

Figure 26 shows the circuit configuration for testing the EMIRR IN+. An RF source is connected to the operational amplifier noninverting input pin using a transmission line. The operational amplifier is configured in a unity-gain buffer topology with the output connected to a low-pass filter (LPF) and a digital multimeter (DMM). A large impedance mismatch at the operational amplifier input causes a voltage reflection; however, this effect is characterized and accounted for when determining the EMIRR IN+. The resulting dc offset voltage is sampled and measured by the multimeter. The LPF isolates the multimeter from residual RF signals that can interfere with multimeter accuracy.

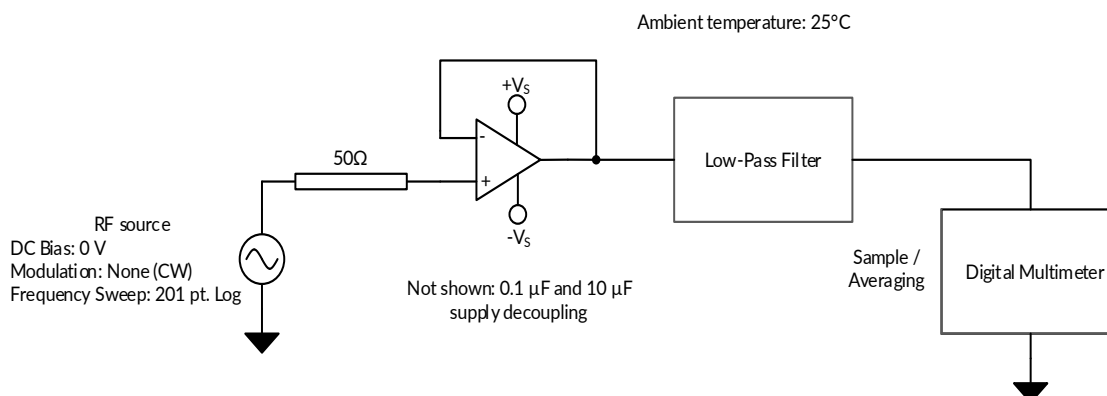


Figure 26. EMIRR IN+ Test Configuration Schematic

9 APPLICATION AND IMPLEMENTATION

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Note

The RS621K series features 7MHz bandwidth and 3.7V/ μ s slew rate with only 700 μ A of supply current per channel, providing good AC performance at low power consumption. DC applications are well served with a low input noise voltage, low input bias current, and a typical input offset voltage of 0.8mV.

Typical Applications

9.2 25-kHz Low-pass Filter

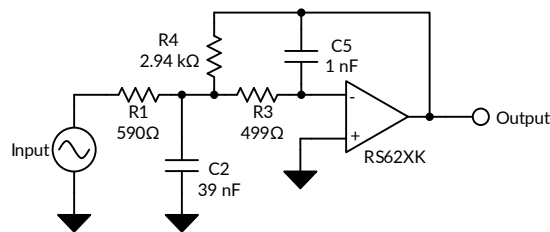


Figure 27. 25-kHz Low-Pass Filter

9.3 Design Requirements

Low-pass filters are commonly employed in signal processing applications to reduce noise and prevent aliasing. The RS621K devices are ideally suited to construct high-speed, high-precision active filters. Figure 27 shows a second-order, low-pass filter commonly encountered in signal processing applications.

Use the following parameters for this design example:

- Gain = 5 V/V (inverting gain)
- Low-pass cutoff frequency = 25 kHz
- Second-order Chebyshev filter response with 3-dB gain peaking in the passband

9.4 Detailed Design Procedure

The infinite-gain multiple-feedback circuit for a low-pass network function is shown in Figure 27. Use Equation 1 to calculate the voltage transfer function.

$$\frac{\text{Output}}{\text{Input}}(s) = \frac{-1/R_1 R_3 C_2 C_5}{s^2 + (s/C_2) + (1/R_1 + 1/R_3 + 1/R_4) + 1/R_3 R_4 C_2 C_5} \quad (1)$$

This circuit produces a signal inversion. For this circuit, the gain at dc and the low-pass cutoff frequency are calculated by Equation 2:

$$\text{Gain} = \frac{R_4}{R_1}$$

$$f_c = \frac{1}{2\pi} \sqrt{(1/R_3 R_4 C_2 C_5)} \quad (2)$$

9.5 Application Curve

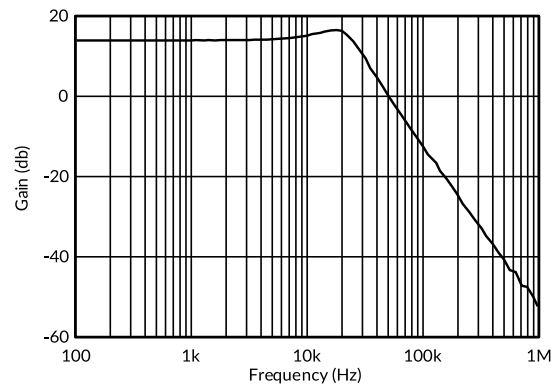


Figure 28. Low-Pass Filter Transfer Function

10 LAYOUT

10.1 Layout Guideline

Attention to good layout practices is always recommended. Keep traces short. When possible, use a PCB ground plane with surface-mount components placed as close to the device pins as possible. Place a $0.1\mu\text{F}$ capacitor closely across the supply pins.

These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI susceptibility.

10.2 Layout Example

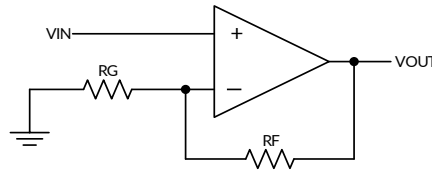


Figure 29. Schematic Representation

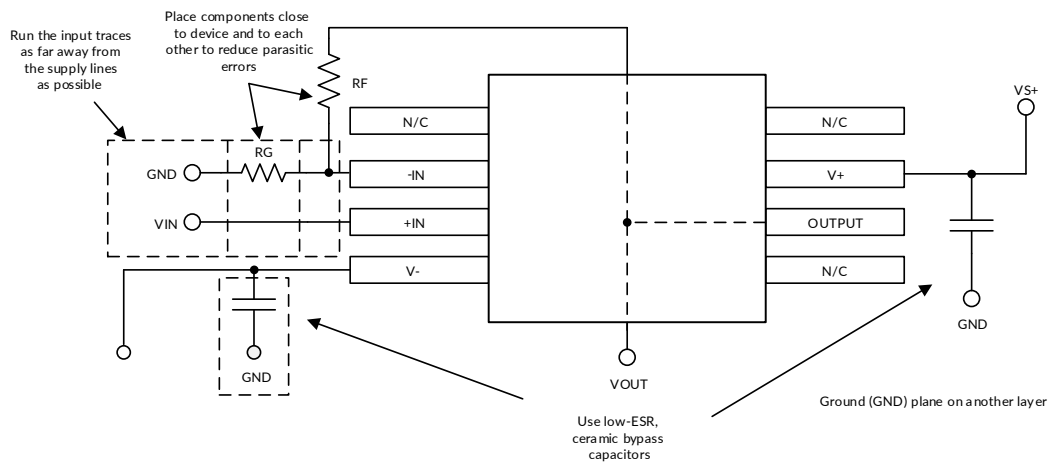
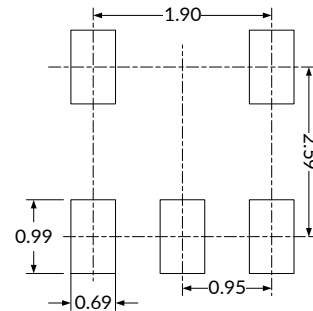
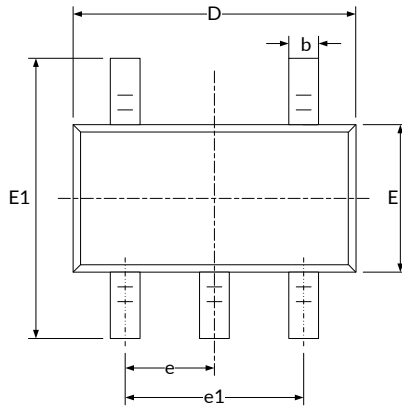
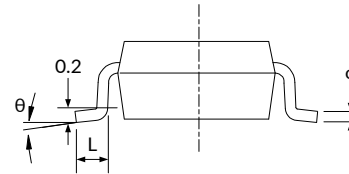
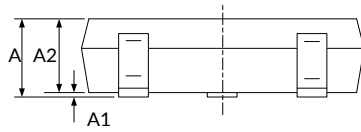


Figure 30. Operational Amplifier Board Layout for Noninverting Configuration

11 PACKAGE OUTLINE DIMENSIONS SOT23-5⁽³⁾



RECOMMENDED LAND PATTERN (Unit: mm)



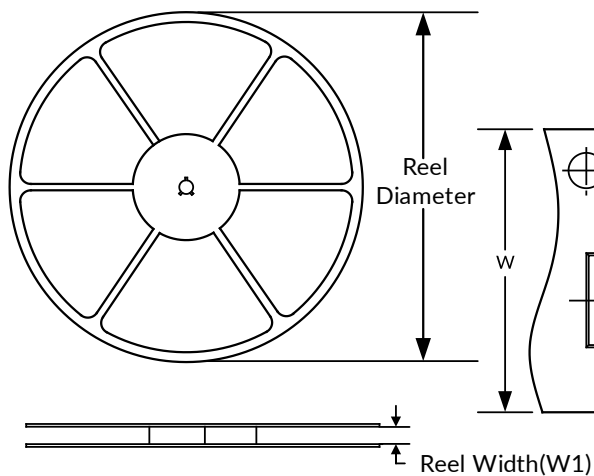
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A ⁽¹⁾	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D ⁽¹⁾	2.820	3.020	0.111	0.119
E ⁽¹⁾	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC) ⁽²⁾		0.037(BSC) ⁽²⁾	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

NOTE:

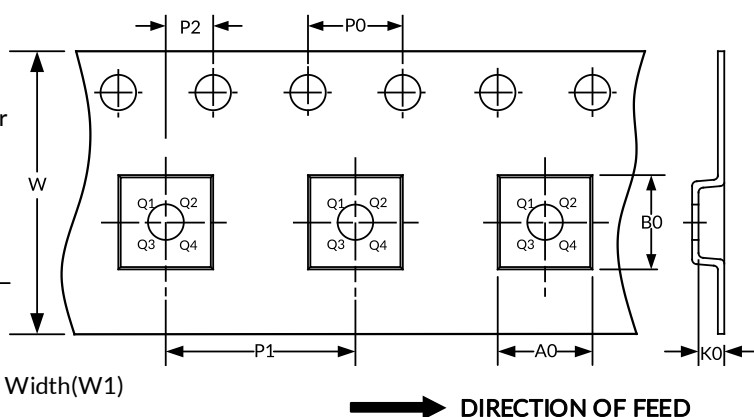
1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
3. This drawing is subject to change without notice.

12 TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3

NOTE:

1. All dimensions are nominal.
2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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